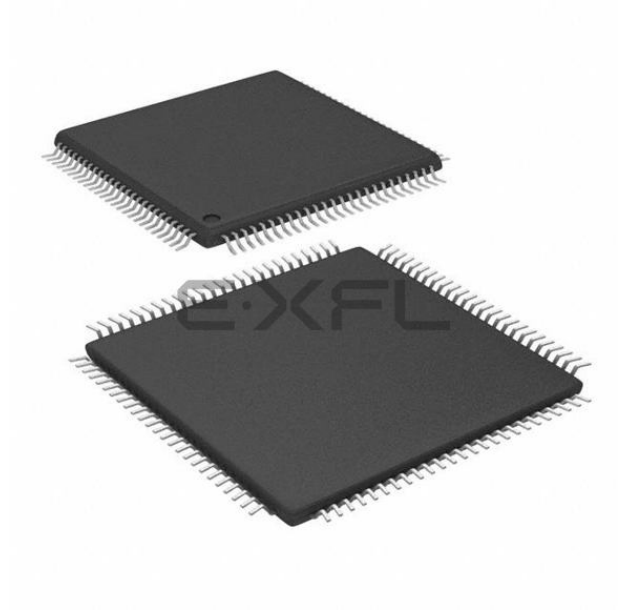

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, LCD, LVD, POR, PWM, WDT
Number of I/O	85
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 50x12b, 2x16b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj64gc010-i-pt

TABLE 4-12: OP AMP REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
AMP1CON	024A	AMPEN	—	AMPSIDL	AMPSLP	INTPOL1	INTPOL0	CMOUT	CMPSEL	SPDSEL	AMPOE	NINSEL2	NINSEL1	NINSEL0	PINSEL2	PINSEL1	PINSEL0	0000
AMP2CON	024C	AMPEN	—	AMPSIDL	AMPSLP	INTPOL1	INTPOL0	CMOUT	CMPSEL	SPDSEL	AMPOE	NINSEL2	NINSEL1	NINSEL0	PINSEL2	PINSEL1	PINSEL0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-13: PORTA REGISTER MAP(1)

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit2	Bit 1	Bit 0	All Resets
TRISA	02C0	TRISA<15:14>		—	—	—	TRISA<10:9>		—	TRISA<7:0>								C6FF
PORTA	02C2	RA<15:14>		—	—	—	RA<10:9>		—	RA<7:0>								xxxx
LATA	02C4	LATA<15:14>		—	—	—	LATA<10:9>		—	LATA<7:0>								xxxx
ODCA	02C6	ODA<15:14>		—	—	—	ODA<10:9>		—	ODA<7:0>								0000

Legend: — = unimplemented, read as '0'; x = unknown value on Reset. Reset values are shown in hexadecimal. Reset values shown are for 100/121-pin devices.
Note 1: PORTA and all associated bits are unimplemented in 64-pin devices.

TABLE 4-14: PORTB REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISB	02C8	TRISB<15:12>				—	—	—	—	TRISB<7:0>								F0FF
PORTB	02CA	RB<15:12>				—	—	—	—	RB<7:0>								xxxx
LATB	02CC	LATB<15:12>				—	—	—	—	LATB<7:0>								xxxx
ODCB	02CE	ODB<15:12>				—	—	—	—	ODB<7:0>								0000

Legend: — = unimplemented, read as '0'; x = unknown value on Reset. Reset values are shown in hexadecimal.

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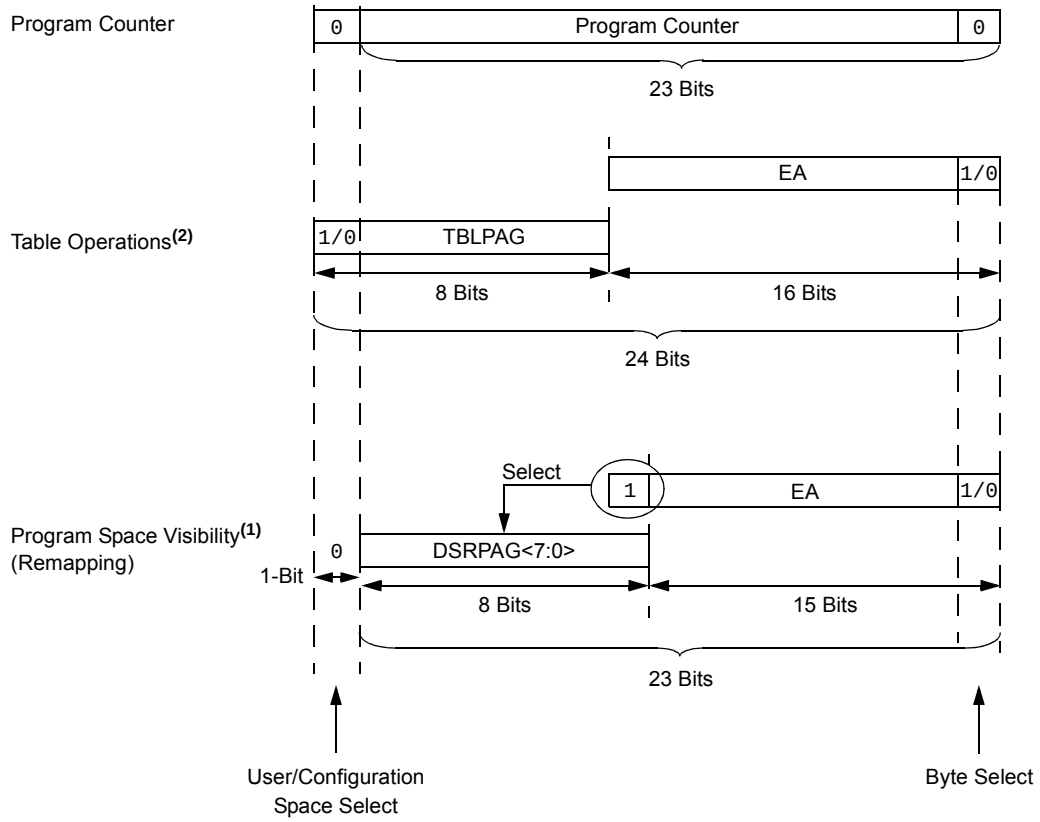
FIGURE 4-8: DATA ACCESS FROM PROGRAM SPACE ADDRESS GENERATION



Note 1: DSRPAG<8> acts as word select. DSRPAG<9> should always be '1' to map program memory to data memory.

2: The instructions, TBLRDH/TBLWTH/TBLRDL/TBLWTL, decide if the higher or lower word of program memory is accessed. TBLRDH/TBLWTH instructions access the higher word and TBLRDL/TBLWTL instructions access the lower word. Table Read operations are permitted in the configuration memory space.

REGISTER 8-19: IEC6: INTERRUPT ENABLE CONTROL REGISTER 6

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	FSTIE	SDA1IE	AMP2IE
bit 15							bit 8

R/W-0	U-0	U-0	R/W-0	U-0	U-0	U-0	U-0
AMP1IE	—	—	LCDIE	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-11 **Unimplemented:** Read as '0'

bit 10 **FSTIE:** FRC Self-Tune Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 9 **SDA1IE:** Sigma-Delta A/D Converter Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 8 **AMP2IE:** Op Amp 2 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 7 **AMP1IE:** Op Amp 1 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 6-5 **Unimplemented:** Read as '0'

bit 4 **LCDIE:** LCD Controller Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 3-0 **Unimplemented:** Read as '0'

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REGISTER 8-43: IPC25: INTERRUPT PRIORITY CONTROL REGISTER 25

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	AMP1IP2	AMP1IP1	AMP1IP0	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
—	—	—	—	—	LCDIP2	LCDIP1	LCDIP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **AMP1IP<2:0>:** Op Amp 1 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11-3 **Unimplemented:** Read as ‘0’

bit 2-0 **LCDIP<2:0>:** LCD Controller Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

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REGISTER 11-21: RPINR20: PERIPHERAL PIN SELECT INPUT REGISTER 20

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SCK1R5	SCK1R4	SCK1R3	SCK1R2	SCK1R1	SCK1R0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SDI1R5	SDI1R4	SDI1R3	SDI1R2	SDI1R1	SDI1R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13-8 **SCK1R<5:0>:** Assign SPI1 Clock Input (SCK1IN) to Corresponding RPn or RPIn Pin bits

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **SDI1R<5:0>:** Assign SPI1 Data Input (SDI1) to Corresponding RPn or RPIn Pin bits

REGISTER 11-22: RPINR21: PERIPHERAL PIN SELECT INPUT REGISTER 21

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U3CTSR5	U3CTSR4	U3CTSR3	U3CTSR2	U3CTSR1	U3CTSR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SS1R5	SS1R4	SS1R3	SS1R2	SS1R1	SS1R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13-8 **U3CTSR<5:0>:** Assign UART3 Clear-to-Send ($\overline{\text{U3CTS}}$) to Corresponding RPn or RPIn Pin bits

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **SS1R<5:0>:** Assign SPI1 Slave Select Input (SS1IN) to Corresponding RPn or RPIn Pin bits

12.0 TIMER1

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"Timers"** (DS39704) which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The Timer1 module is a 16-bit timer, which can serve as the time counter for the Real-Time Clock (RTC) or operate as a free-running, interval timer/counter. Timer1 can operate in three modes:

- 16-Bit Timer
- 16-Bit Synchronous Counter
- 16-Bit Asynchronous Counter

Timer1 also supports these features:

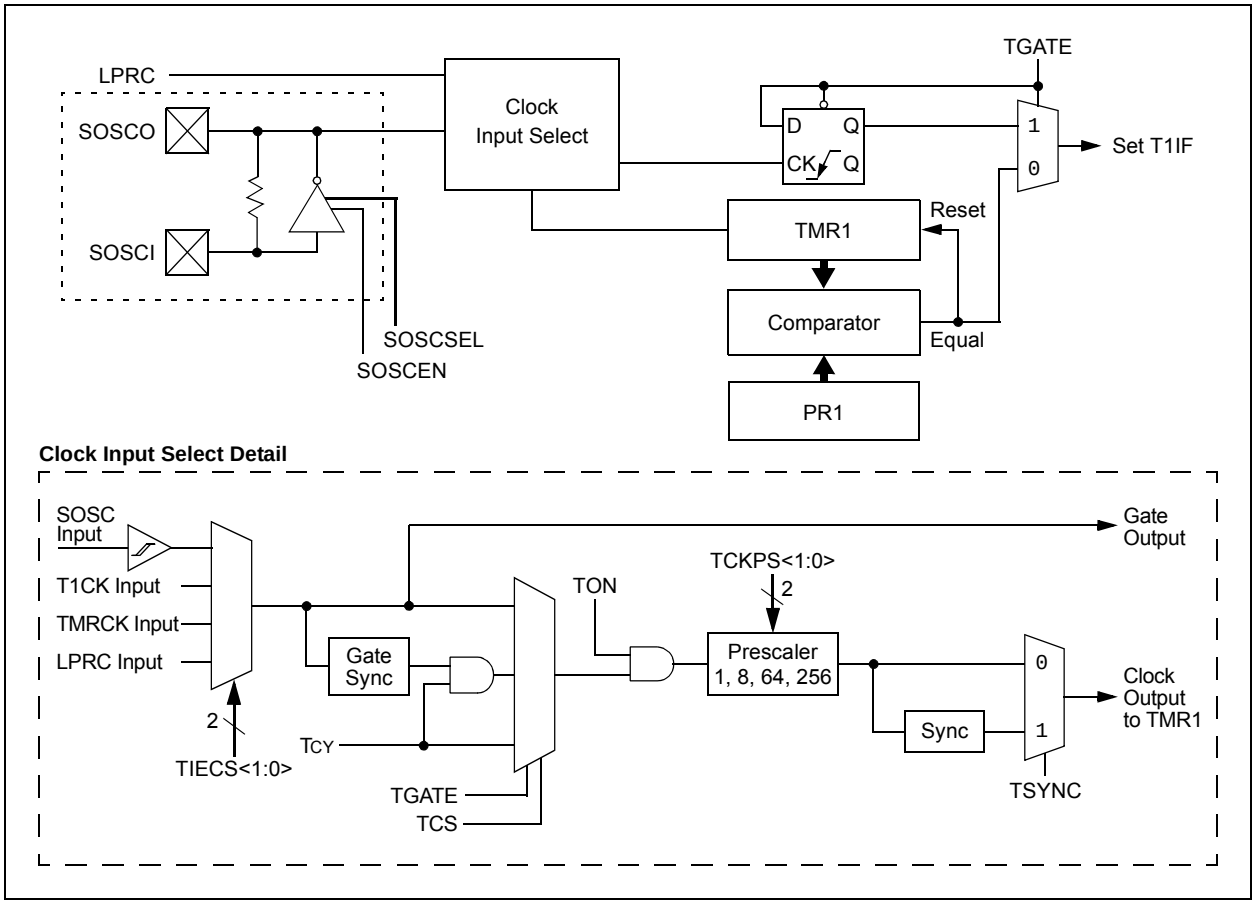
- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation During CPU Idle and Sleep modes
- Interrupt on 16-Bit Period Register Match or Falling Edge of External Gate Signal

Figure 12-1 presents a block diagram of the 16-bit timer module.

To configure Timer1 for operation:

1. Set the TON bit (= 1).
2. Select the timer prescaler ratio using the TCKPS<1:0> bits.
3. Set the Clock and Gating modes using the TCS, TIECS<1:0> and TGATE bits.
4. Set or clear the TSYNC bit to configure synchronous or asynchronous operation.
5. Load the timer period value into the PR1 register.
6. If interrupts are required, set the Timer1 Interrupt Enable bit, T1IE. Use the Timer1 Interrupt Priority bits, T1IP<2:0>, to set the interrupt priority.

FIGURE 12-1: 16-BIT TIMER1 MODULE BLOCK DIAGRAM



14.1.2 CASCADED (32-BIT) MODE

By default, each module operates independently with its own 16-bit timer. To increase resolution, adjacent even and odd modules can be configured to function as a single 32-bit module. (For example, Modules 1 and 2 are paired, as are Modules 3 and 4, and so on.) The odd numbered module (ICx) provides the Least Significant 16 bits of the 32-bit register pairs and the even module (ICy) provides the Most Significant 16 bits. Wrap-arounds of the ICx registers cause an increment of their corresponding ICy registers.

Cascaded operation is configured in hardware by setting the IC32 bits (ICxCON2<8>) for both modules.

14.2 Capture Operations

The input capture module can be configured to capture timer values and generate interrupts on rising edges on ICx or all transitions on ICx. Captures can be configured to occur on all rising edges or just some (every 4th or 16th). Interrupts can be independently configured to generate on each event or a subset of events.

To set up the module for capture operations:

1. Configure the ICx input for one of the available Peripheral Pin Select pins.
2. If Synchronous mode is to be used, disable the sync source before proceeding.
3. Make sure that any previous data has been removed from the FIFO by reading ICxBUF until the ICBNE bit (ICxCON1<3>) is cleared.
4. Set the SYNCSEL<4:0> bits (ICxCON2<4:0>) to the desired sync/trigger source.
5. Set the ICTSEL<2:0> bits (ICxCON1<12:10>) for the desired clock source.
6. Set the ICI<1:0> bits (ICxCON1<6:5>) to the desired interrupt frequency
7. Select Synchronous or Trigger mode operation:
   a) Check that the SYNCSELx bits are not set to '00000'.
   b) For Synchronous mode, clear the ICTRIG bit (ICxCON2<7>).
   c) For Trigger mode, set ICTRIG and clear the TRIGSTAT bit (ICxCON2<6>).
8. Set the ICM<2:0> bits (ICxCON1<2:0>) to the desired operational mode.
9. Enable the selected sync/trigger source.

For 32-bit cascaded operations, the setup procedure is slightly different:

1. Set the IC32 bits for both modules (ICyCON2<8> and ICxCON2<8>), enabling the even numbered module first. This ensures that the modules will start functioning in unison.
2. Set the ICTSELx and SYNCSELx bits for both modules to select the same sync/trigger and time base source. Set the even module first, then the odd module. Both modules must use the same ICTSELx and SYNCSELx bits settings.
3. Clear the ICTRIG bit of the even module (ICyCON2<7>). This forces the module to run in Synchronous mode with the odd module, regardless of its trigger setting.
4. Use the odd module's ICIx bits (ICxCON1<6:5>) to set the desired interrupt frequency.
5. Use the ICTRIG bit of the odd module (ICxCON2<7>) to configure Trigger or Synchronous mode operation.

Note:	For Synchronous mode operation, enable the sync source as the last step. Both input capture modules are held in Reset until the sync source is enabled.

6. Use the ICMx bits of the odd module (ICxCON1<2:0>) to set the desired Capture mode.

The module is ready to capture events when the time base and the sync/trigger source are enabled. When the ICBNE bit (ICxCON1<3>) becomes set, at least one capture value is available in the FIFO. Read input capture values from the FIFO until the ICBNE clears to '0'.

For 32-bit operation, read both the ICxBUF and ICyBUF for the full 32-bit timer value (ICxBUF for the lsw, ICyBUF for the msw). At least one capture value is available in the FIFO buffer when the odd module's ICBNE bit (ICxCON1<3>) becomes set. Continue to read the buffer registers until ICBNE is cleared (performed automatically by hardware).

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17.2 Setting Baud Rate When Operating as a Bus Master

To compute the Baud Rate Generator reload value, use Equation 17-1.

EQUATION 17-1: COMPUTING BAUD RATE RELOAD VALUE(1,2)

$$FSCL = \frac{FCY}{I2CxBRG + 1 + \frac{FCY}{10{,}000{,}000}}$$

or:

$$I2CxBRG = \left(\frac{FCY}{FSCL} - \frac{FCY}{10{,}000{,}000} - 1\right)$$

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

2: These clock rate values are for guidance only. The actual clock rate can be affected by various system-level parameters. The actual clock rate should be measured in its intended application.

17.3 Slave Address Masking

The I2CxMSK register (Register 17-3) designates address bit positions as “don’t care” for both 7-Bit and 10-Bit Addressing modes. Setting a particular bit location (= 1) in the I2CxMSK register causes the slave module to respond, whether the corresponding address bit value is a ‘0’ or a ‘1’. For example, when I2CxMSK is set to ‘00100000’, the slave module will detect both addresses, ‘0000000’ and ‘0100000’.

To enable address masking, the Intelligent Peripheral Management Interface (IPMI) must be disabled by clearing the IPMIEN bit (I2CxCON<11>).

Note: As a result of changes in the I2C protocol, the addresses in Table 17-2 are reserved and will not be Acknowledged in Slave mode. This includes any address mask settings that include any of these addresses.

TABLE 17-1: I2C CLOCK RATES(1,2)

Required System FSCL	FCY	I2CxBRG Value		Actual FSCL
		(Decimal)	(Hexadecimal)	
100 kHz	16 MHz	157	9D	100 kHz
100 kHz	8 MHz	78	4E	100 kHz
100 kHz	4 MHz	39	27	99 kHz
400 kHz	16 MHz	37	25	404 kHz
400 kHz	8 MHz	18	12	404 kHz
400 kHz	4 MHz	9	9	385 kHz
400 kHz	2 MHz	4	4	385 kHz
1 MHz	16 MHz	13	D	1.026 MHz
1 MHz	8 MHz	6	6	1.026 MHz
1 MHz	4 MHz	3	3	0.909 MHz

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

2: These clock rate values are for guidance only. The actual clock rate can be affected by various system-level parameters. The actual clock rate should be measured in its intended application.

TABLE 17-2: I2C RESERVED ADDRESSES(1)

Slave Address	R/$\overline{W}$ Bit	Description
0000 000	0	General Call Address(2)
0000 000	1	Start Byte
0000 001	x	Cbus Address
0000 01x	x	Reserved
0000 1xx	x	HS Mode Master Code
1111 0xx	x	10-Bit Slave Upper Byte(3)
1111 1xx	x	Reserved

Note 1: The address bits listed here will never cause an address match, independent of address mask settings.

2: The address will be Acknowledged only if GCEN = 1.

3: A match on this address can only occur on the upper byte in 10-Bit Addressing mode.

REGISTER 19-18: U1IE: USB INTERRUPT ENABLE REGISTER (ALL USB MODES)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STALLIE	ATTACHIE(1)	RESUMEIE	IDLEIE	TRNIE	SOFIE	UERRIE	URSTIE DETACHIE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 **STALLIE:** STALL Handshake Interrupt Enable bit
1 = Interrupt is enabled
0 = Interrupt is disabled

bit 6 **ATTACHIE:** Peripheral Attach Interrupt bit (Host mode only)(1)
1 = Interrupt is enabled
0 = Interrupt is disabled

bit 5 **RESUMEIE:** Resume Interrupt bit
1 = Interrupt is enabled
0 = Interrupt is disabled

bit 4 **IDLEIE:** Idle Detect Interrupt bit
1 = Interrupt is enabled
0 = Interrupt is disabled

bit 3 **TRNIE:** Token Processing Complete Interrupt bit
1 = Interrupt is enabled
0 = Interrupt is disabled

bit 2 **SOFIE:** Start-of-Frame Token Interrupt bit
1 = Interrupt is enabled
0 = Interrupt is disabled

bit 1 **UERRIE:** USB Error Condition Interrupt bit
1 = Interrupt is enabled
0 = Interrupt is disabled

bit 0 **URSTIE or DETACHIE:** USB Reset Interrupt (Device mode) or USB Detach Interrupt (Host mode) Enable bit
1 = Interrupt is enabled
0 = Interrupt is disabled

Note 1: This bit is unimplemented in Device mode, read as '0'.

REGISTER 21-3: PMCON3: EPMP CONTROL REGISTER 3

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
PTWREN	PTRDEN	PTBE1EN	PTBE0EN	—	AWAITM1	AWAITM0	AWAITE
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	PTEN22(1)	PTEN21(1)	PTEN20(1)	PTEN19(1)	PTEN18(1)	PTEN17(1)	PTEN16(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **PTWREN:** EPMP Write/Enable Strobe Port Enable bit
1 = PMWR/PMENB port is enabled
0 = PMWR/PMENB port is disabled

bit 14 **PTRDEN:** EPMP Read/Write Strobe Port Enable bit
1 = PMRD/$\overline{\text{PMWR}}$ port is enabled
0 = PMRD/$\overline{\text{PMWR}}$ port is disabled

bit 13 **PTBE1EN:** EPMP High Nibble/Byte Enable Port Enable bit
1 = PMBE1 port is enabled
0 = PMBE1 port is disabled

bit 12 **PTBE0EN:** EPMP Low Nibble/Byte Enable Port Enable bit
1 = PMBE0 port is enabled
0 = PMBE0 port is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-9 **AWAITM<1:0>:** Address Latch Strobe Wait States bits
11 = Wait of 3½ TCY
10 = Wait of 2½ TCY
01 = Wait of 1½ TCY
00 = Wait of ½ TCY

bit 8 **AWAITE:** Address Hold After Address Latch Strobe Wait States bit
1 = Wait of 1¼ TCY
0 = Wait of ¼ TCY

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **PTEN<22:16>:** EPMP Address Port Enable bits(1)
1 = PMA<22:16> function as EPMP address lines
0 = PMA<22:16> function as port I/Os

Note 1: These bits are not available in 64-pin devices (PIC24FJXXXGC006).

REGISTER 21-9: PADCFG1: PAD CONFIGURATION CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	PMPTTL
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-1 **Unimplemented:** Read as ‘0’

bit 0 **PMPTTL:** EPMP Module TTL Input Buffer Select bit

1 = EPMP module inputs (PMDx, PMCS1) use TTL input buffers

0 = EPMP module inputs use Schmitt Trigger input buffers

TABLE 22-1: LCDDATA REGISTERS AND BITS FOR SEGMENT AND COM COMBINATIONS

COM Lines	Segments			
	0 to 15	16 to 31	32 to 47	48 to 62
0	LCDDATA0 S00C0:S15C0	LCDDATA1 S16C0:S31C0	LCDDATA2 S32C0:S47C0	LCDDATA3 S48C0:S63C0
1	LCDDATA4 S00C1:S15C1	LCDDATA5 S16C1:S31C1	LCDDATA6 S32C1:S47C1	LCDDATA7 S48C1:S63C1
2	LCDDATA8 S00C2:S15C2	LCDDATA9 S16C2:S31C2	LCDDATA10 S32C2:S47C2	LCDDATA11 S48C2:S63C2
3	LCDDATA12 S00C3:S15C3	LCDDATA13 S16C3:S31C3	LCDDATA14 S32C3:S47C3	LCDDATA15 S48C3:S63C3
4	LCDDATA16 S00C4:S15C4	LCDDATA17 S16C4:S31C4	LCDDATA18 S32C4:S47C4	LCDDATA19 S48C4:S59C4
5	LCDDATA20 S00C5:S15C5	LCDDATA21 S16C5:S31C5	LCDDATA22 S32C5:S47C5	LCDDATA23 S48C5:S69C5
6	LCDDATA24 S00C6:S15C6	LCDDATA25 S16C6:S31C6	LCDDATA26 S32C6:S47C6	LCDDATA27 S48C6:S59C6
7	LCDDATA28 S00C7:S15C7	LCDDATA29 S16C7:S31C7	LCDDATA30 S32C7:S47C7	LCDDATA31 S48C7:S59C7

24.0 32-BIT PROGRAMMABLE CYCLIC REDUNDANCY CHECK (CRC) GENERATOR

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"32-Bit Programmable Cyclic Redundancy Check (CRC)"** (DS30009729) which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

The 32-bit programmable CRC generator provides a hardware implemented method of quickly generating checksums for various networking and security applications. It offers the following features:

- User-Programmable CRC Polynomial Equation, up to 32 Bits
- Programmable Shift Direction (little or big-endian)
- Independent Data and Polynomial Lengths
- Configurable Interrupt Output
- Data FIFO

Figure 24-1 displays a simplified block diagram of the CRC generator. A simple version of the CRC shift engine is displayed in Figure 24-2.

FIGURE 24-1: CRC BLOCK DIAGRAM

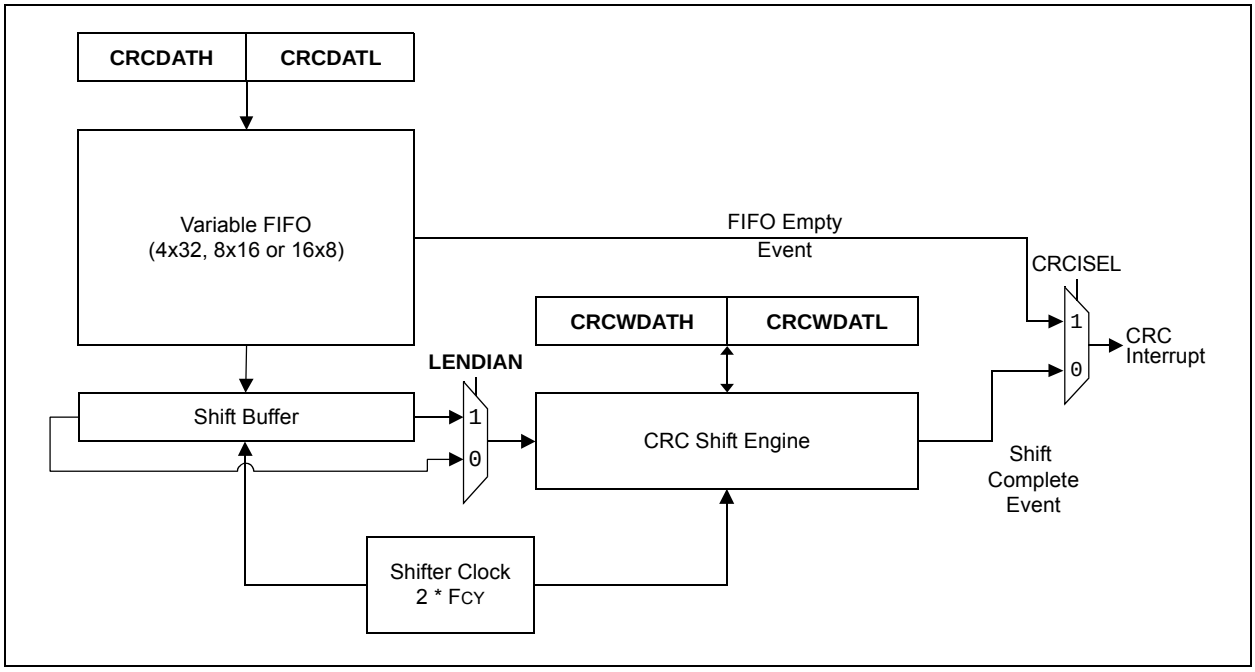
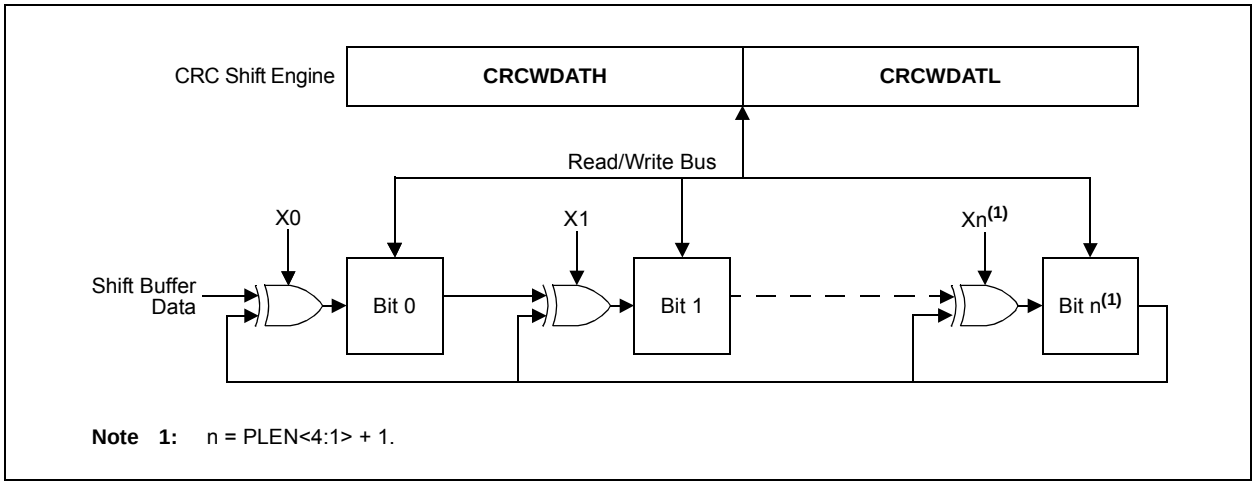


FIGURE 24-2: CRC SHIFT ENGINE DETAIL



Note 1: n = PLEN<4:1> + 1.

FIGURE 30-3: INDIVIDUAL COMPARATOR CONFIGURATIONS WHEN CREF = 1 AND CVREFP = 0

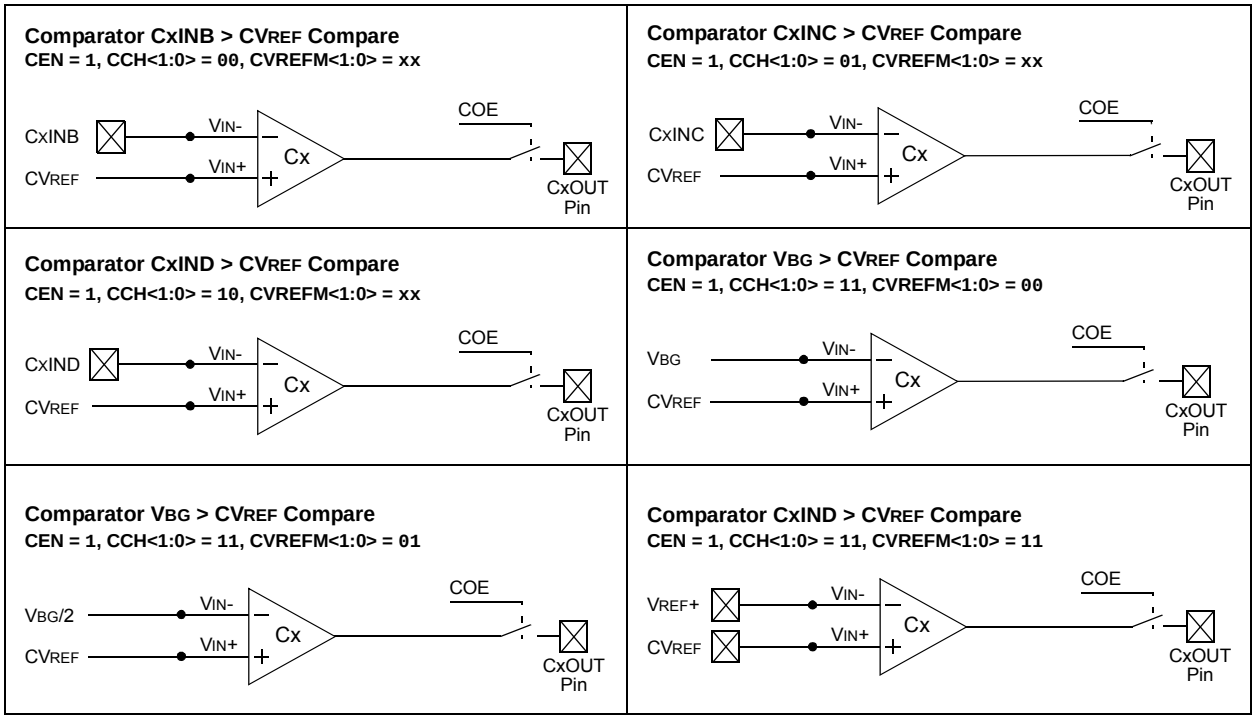


FIGURE 30-4: INDIVIDUAL COMPARATOR CONFIGURATIONS WHEN CREF = 1 AND CVREFP = 1

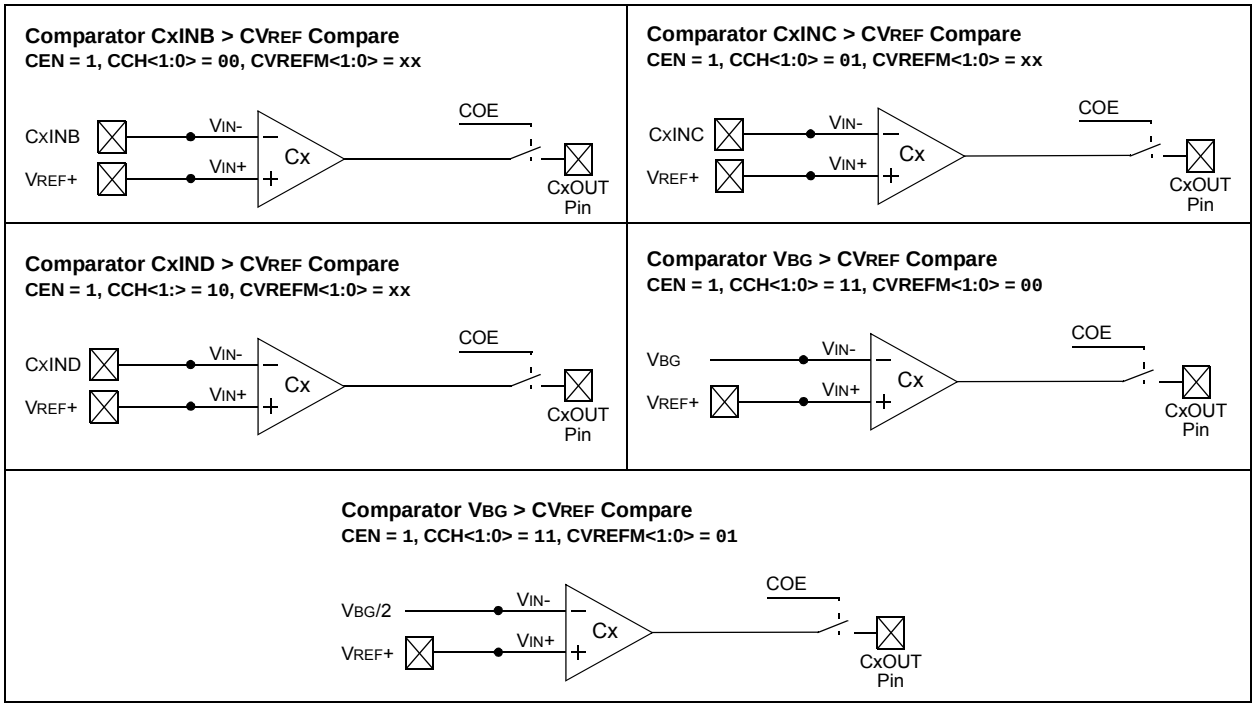


TABLE 37-7: DC CHARACTERISTICS: ∆ CURRENT (BOR, WDT, DSBOR, DSWDT, LCD)

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Operating Temperature**	**VDD**	**Conditions**
Incremental Current Brown-out Reset (∆BOR)(2)						
DC25	3.1	5.0	µA	-40°C to +85°C	2.0V	∆BOR(2)
	4.3	6.0	µA	-40°C to +85°C	3.3V	
Incremental Current Watchdog Timer (∆WDT)(2)						
DC71	0.8	1.5	µA	-40°C to +85°C	2.0V	∆WDT (with LPRC selected)(2)
	0.8	1.5	µA	-40°C to +85°C	3.3V	
Incremental Current HLVD (∆HLVD)(2)						
DC75	4.2	15	µA	-40°C to +85°C	2.0V	∆HLVD(2)
	4.2	15	µA	-40°C to +85°C	3.3V	
Incremental Current Real-Time Clock and Calendar (∆RTCC)(2)						
DC77	0.30	1.0	µA	-40°C to +85°C	2.0V	∆RTCC (with SOSC)(2)
	0.35	1.0	µA	-40°C to +85°C	3.3V	
DC77a	0.30	1.0	µA	-40°C to +85°C	2.0V	∆RTCC (with LPRC)(2)
	0.35	1.0	µA	-40°C to +85°C	3.3V	
Incremental Current Deep Sleep BOR (∆DSBOR)(2)						
DC81	0.11	0.40	µA	-40°C to +85°C	2.0V	∆Deep Sleep BOR(2)
	0.12	0.40	µA	-40°C to +85°C	3.3V	
Incremental Current Deep Sleep Watchdog Timer Reset (∆DSWDT)(2)						
DC80	0.24	0.40	µA	-40°C to +85°C	2.0V	∆Deep Sleep WDT(2)
	0.24	0.40	µA	-40°C to +85°C	3.3V	
Incremental Current LCD (∆LCD)(2)						
DC82	0.8	3.0	µA	-40°C to +85°C	3.3V	∆LCD external/internal;(2,3) 1/8 MUX, 1/3 Bias
DC90	20	—	µA	-40°C to +85°C	2.0V	∆LCD charge pump;(2,4) 1/8 MUX, 1/3 Bias
	24	—	µA	-40°C to +85°C	3.3V	
VBAT A/D Monitor(5)						
DC91	1.5	—	µA	-40°C to +85°C	3.3V	VBAT = 2V
	4.0	—	µA	-40°C to +85°C	3.3V	VBAT = 3.3V

Note 1: Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Incremental current while the module is enabled and running.

3: LCD is enabled and running, no glass is connected; the resistor ladder current is not included.

4: LCD is enabled and running, no glass is connected.

5: The A/D channel is connected to the VBAT pin internally; this is the current during A/D VBAT operation.

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TABLE 37-13: VBAT OPERATING VOLTAGE SPECIFICATIONS

Param No.	Symbol	Characteristic	Min	Typ	Max	Units	Comments
DVB01	VBT	Operating Voltage	1.6	—	3.6	V	Battery connected to the VBAT pin, VBTBOR = 0
DVB02			VBATBOR	—	3.6	V	Battery connected to the VBAT pin, VBTBOR = 1
DVB10	VBTADC	VBAT A/D Monitoring Voltage Specification(1)	1.6	—	3.6	V	A/D monitoring the VBAT pin using the internal A/D channel

Note 1: Measuring the A/D value using the A/D is represented by the equation: Measured Voltage = ((VBAT/2)/VDD) * 4096) for 12-bit A/D.

TABLE 37-14: CTMU CURRENT SOURCE SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial					
Param No.	Sym	Characteristic	Min	Typ(1)	Max	Units	Comments	Conditions
DCT10	IOUT1	CTMU Current Source, Base Range	—	550	—	nA	CTMUICON<1:0> = 00(2)	2.5V < VDD < VDDMAX
DCT11	IOUT2	CTMU Current Source, 10x Range	—	5.5	—	µA	CTMUICON<1:0> = 01	
DCT12	IOUT3	CTMU Current Source, 100x Range	—	55	—	µA	CTMUICON<1:0> = 10	
DCT13	IOUT4	CTMU Current Source, 1000x Range	—	550	—	µA	CTMUICON<1:0> = 11(2)	
DCT21	VDELTA1	Temperature Diode Voltage Change per Degree Celsius	—	-1.8	—	mV/°C	Current = 5.5 µA	
DCT22	VDELTA2	Temperature Diode Voltage Change per Degree Celsius	—	-1.55	—	mV/°C	Current = 55 µA	
DCT23	VD1	Forward Voltage	—	710	—	mV	At 0ºC, 5.5 µA	
DCT24	VD2	Forward Voltage	—	760	—	mV	At 0ºC, 55 µA	

Note 1: Nominal value at center point of current trim range (CTMUICON<7:2> = 000000).

2: Do not use this current range with a temperature sensing diode.

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TABLE 37-19: OPERATIONAL AMPLIFIER SPECIFICATIONS

Operating Conditions: -40°C < TA < +85°C, 2.0V < (A)VDD < 3.6V							
Param No.	**Sym**	**Characteristics**	**Min**	**Typ**	**Max**	**Units**	**Comments**
Op Amp Mode Specifications							
CM20a	SR	Slew Rate	—	1.2	—	V/µs	SPDSEL = 1
CM20b			—	0.4	—	V/µs	SPDSEL = 0
CM23	GBW	Gain Bandwidth Product	—	2.5	—	MHz	SPDSEL = 1
			—	0.5	—	MHz	SPDSEL = 0
CM33	VGAIN	DC Open-Loop Gain	—	80	—	dB	
CM40	VOFFSET	Input Offset Voltage	—	±2	±14	mV	
CM42	VCMR	Common-Mode Input Voltage Range	AVSS	—	AVDD	V	
CM45	IB	Input Bias Current	—	—	—	nA	**(Note 1)**
CM52	VOAMAX	Maximum Output Voltage Swing	AVSS + 50	—	AVDD – 50	mV	0.5V input overdrive, no output loading
CM53	IOA	Maximum Continuous Output Current Rating (DC or RMS AC)	—	—	±6	mA	This value is not tested in production
CM54a	IQOA	AVDD Quiescent Current	—	190	—	µA	Module enabled, SPDSEL = 1, no output load
CM54b			—	40	—	µA	Module enabled, SPDSEL = 0, no output load
Comparator Mode Specifications							
CM10a	TRESPL	Large Signal Comparator Response Time	—	500	—	ns	SPDSEL = 1, 3V step with 1.5V input overdrive
			—	2.6	—	µs	SPDSEL = 0, 3V step with 1.5V input overdrive
CM10b	TRESPS	Small Signal Comparator Response Time	—	1.6	—	µs	SPDSEL = 1, 50 mV step with 15 mV input overdrive
			—	4.6	—	µs	SPDSEL = 0, 50 mV step with 15 mV input overdrive
CM15	VCMCR	Common-Mode Input Voltage Range	AVSS	—	AVDD	V	
CM16	TRF	Rise/Fall Time	—	20	—	ns	SPDSEL = 1

Note 1: The op amps use CMOS input circuitry with negligible input bias current. The maximum “effective bias current” is the I/O pin leakage specified by electrical Parameter DI51.

TABLE 37-27: RESET AND BROWN-OUT RESET REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial				
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ**	**Max**	**Units**	**Conditions**
SY10	TMCL	$\overline{\text{MCLR}}$ Pulse Width (Low)	2	—	—	μs	
SY12	TPOR	Power-on Reset Delay	—	2	—	μs	
SY13	TIOZ	I/O High-Impedance from $\overline{\text{MCLR}}$ Low or Watchdog Timer Reset	Lesser of: (3 TCY + 2) or 700	—	(3 TCY + 2)	μs	
SY25	TBOR	Brown-out Reset Pulse Width	1	—	—	μs	VDD ≤ VBOR
SY45	TRST	Internal State Reset Time	—	50	—	μs	
SY70	TDSWU	Deep Sleep Wake-up Time	—	200	—	μs	VCAP fully discharged before wake-up
SY71	TPM	Program Memory Wake-up Time	—	20	—	μs	Sleep wake-up with PMSLP = 0
			—	1	—	μs	Sleep wake-up with PMSLP = 1
SY72	TLVR	Low-Voltage Regulator Wake-up Time	—	90	—	μs	Sleep wake-up with PMSLP = 0
			—	70	—	μs	Sleep wake-up with PMSLP = 1

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FIGURE 38-27: PIN VOH vs. IOUT (VDD = 2.0V)

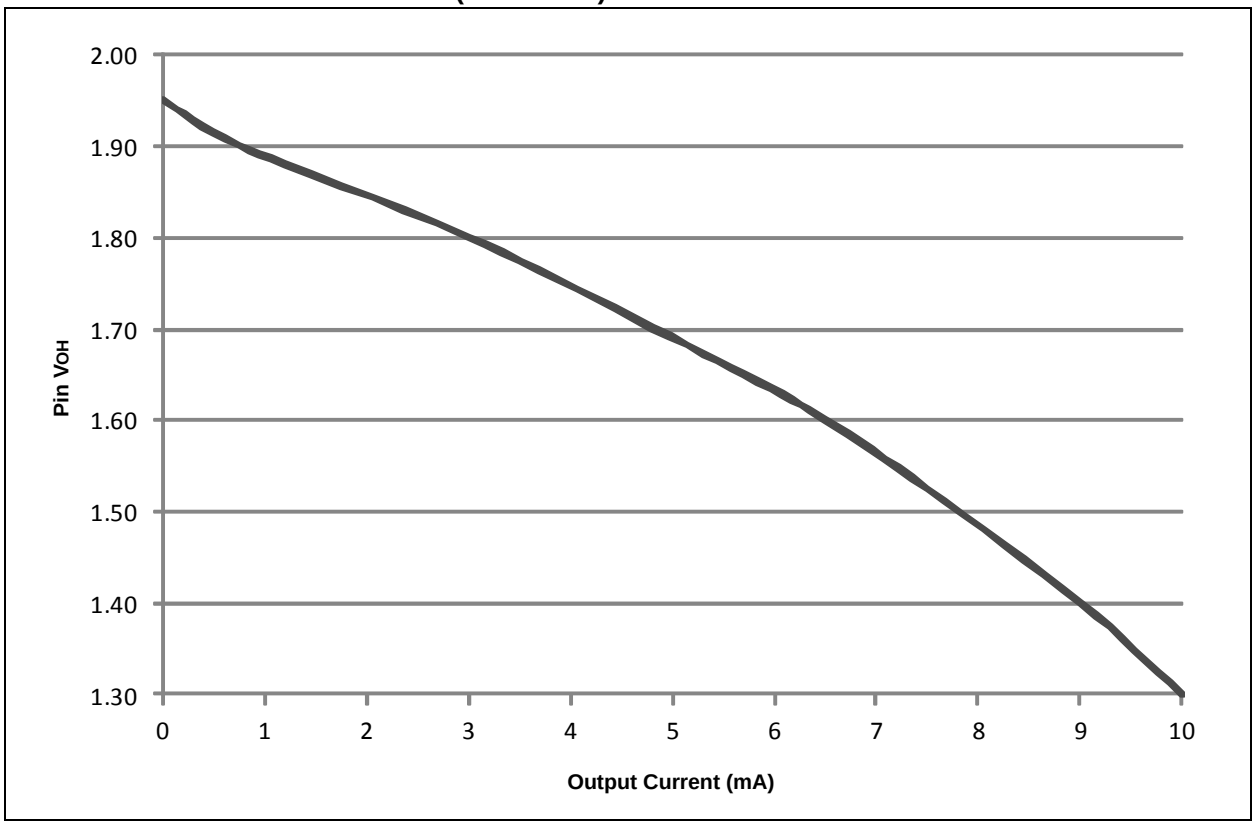
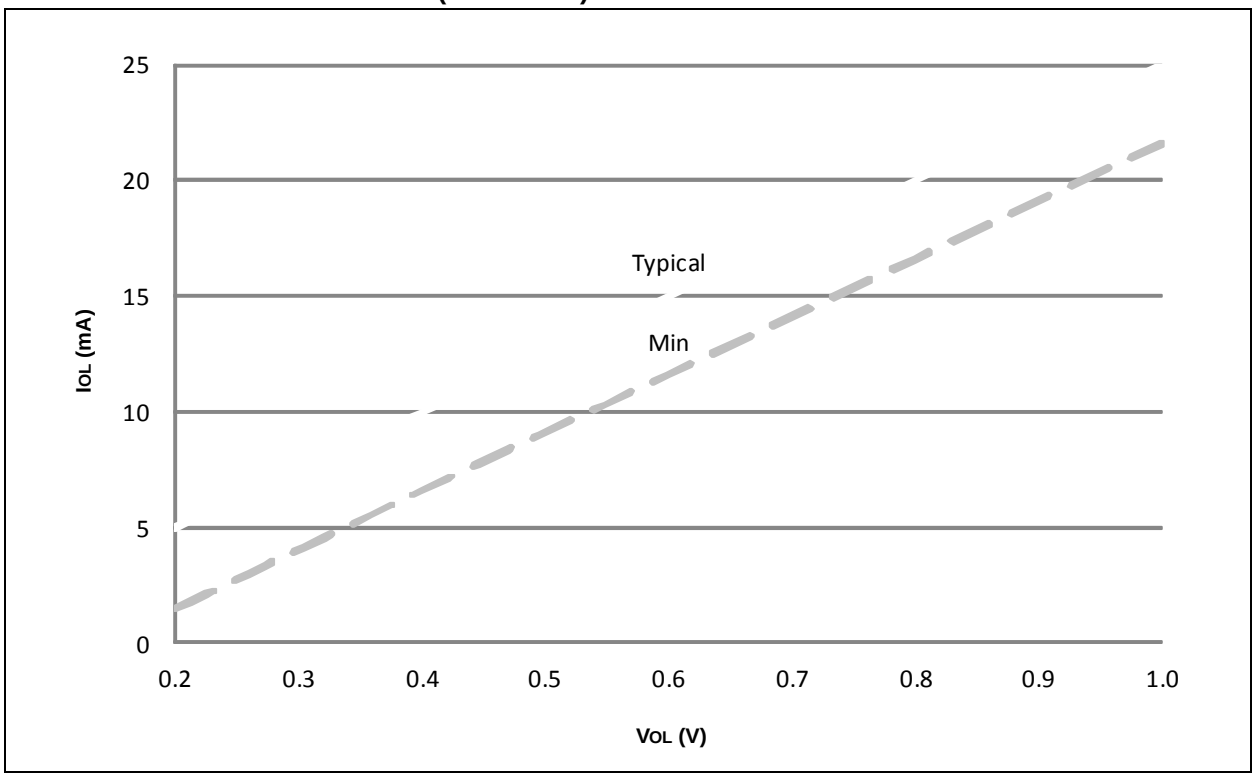


FIGURE 38-28: IOL vs. PIN VOL (VDD = 3.6V)



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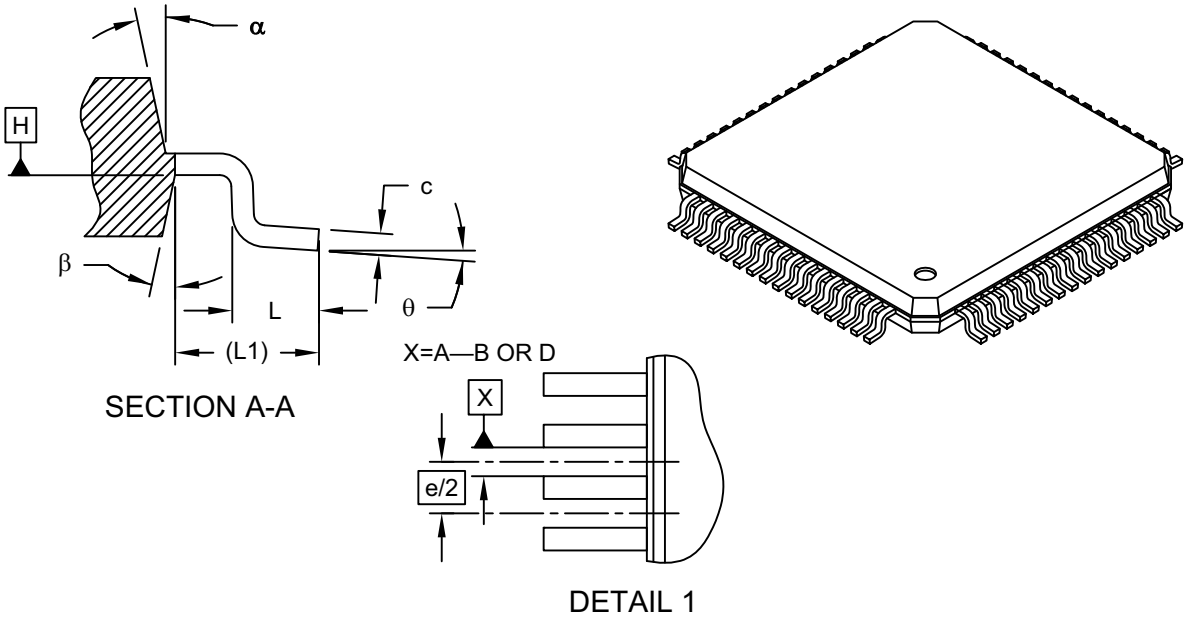
64-Lead Plastic Thin Quad Flatpack (PT)-10x10x1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		64	
Lead Pitch	e		0.50 BSC	
Overall Height	A	-	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	-	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ϕ	0°	3.5°	7°
Overall Width	E		12.00 BSC	
Overall Length	D		12.00 BSC	
Molded Package Width	E1		10.00 BSC	
Molded Package Length	D1		10.00 BSC	
Lead Thickness	c	0.09	-	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085C Sheet 2 of 2